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DP83910A CMOS SNI Serial Network Interface

General Description

The DP83910A CMOS Serial Network Interface (SNI) is a direct-pin equivalent of the bipolar DP8391 SNI and provides the Manchester data encoding and decoding functions for IEEE 802.3 Ethernet/Thin-Ethernet type local area networks. The SNI interfaces the DP8390 Network Interface Controller (NIC) to the DP8392 CTI or an Ethernet transceiver cable. When transmitting, the SNI converts non-return-to-zero (NRZ) data from the controller into Manchester data and sends the converted data differentially to the transceiver. Conversely, when receiving, a Phase Lock Loop decodes the 10 Mbit/s data from the transceiver into NRZ data for the controller.

The DP83910A operates in conjunction with the DP8392 Coaxial Transceiver Interface (CTI) and the DP8390 Network Interface Controller (NIC) to form a three-chip set that implements a complete IEEE 802.3 compatible network as shown below. The DP83910A is a functionally complete Manchester encoder/decoder including a balanced driver and receiver, on-board crystal oscillator, collision signal translator, and a diagnostic loopback feature. The DP83910A, fabricated CMOS, typically consumes less than 70 mA of current. However, as a result of being CMOS, the DP83910A's differential signals must be isolated in both Ethernet and thin wire Ethernet.

Features

- Compatible with Ethernet I, IEEE 802.3; 10BASE5, 10BASE2, and 10BASE-T
- Designed to interface with 10BASE-T transceivers
- Functional and pin-out duplicate of the DP8391
- 10 Mbits/s Manchester encoding/decoding with receive clock recovery
- Requires no precision components
- Loopback capability for diagnostics
- Externally selectable half or full step modes of operation at transmit output
- Squelch circuitry at the receive and collision inputs to reject noise
- TTL/MOS compatible controller interface



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3.0 Functional Description

- The DP83910A consists of five main logical blocks:
- a) The oscillator generates the 10 MHz transmit clock signal for system timing.
- b) The Manchester encoder accepts NRZ data from the controller, encodes the data to Manchester, and transmits it differentially to the transceiver, through the differential transmit driver.
- c) The Manchester decoder receives Manchester data from the transceiver, converts it to NRZ data and clock pulses, and sends it to the controller.
- d) The collision translator indicates to the controller the presence of a valid 10 MHz collision signal to the PLL.
- e) The loopback circuitry, when asserted, routes the data from the Manchester encoder back to the PLL decoder.

3.1 OSCILLATOR

The oscillator is controlled by a 20 MHz parallel resonant crystal connected between X1 and X2 or by an external clock on X1. The 20 MHz output of the oscillator is divided by 2 to generate the 10 MHz transmit clock for the controller. The oscillator also provides internal clock signals to the encoding and decoding circuits.

If a crystal is connected to the DP83910A, it is recommended that the circuit shown in *Figure 1* be used and that the components used meet the following:

Crystal XT1: AT cut parallel resonant crystal Series Resistance: $\leq 10\Omega$

Specified Load Capacitance: 13.5 pF Accuracy: 0.005% (50 ppm)

C1, C2: Load Capacitor, 27 pF.

The resistor, R1, in *Figure 1* may be required in order to minimize frequency drift due to changes in the V_{CC} supply voltage. If R1 is required, it's value must be carefully selected. R1 decreases the loop gain. Thus, if R1 is made too large, the loop gain will be greatly reduced and the crystal will not oscillate. If R1 is made too small, normal variations in the V_{CC} may cause the oscillation frequency to drift out of specification. As the first rule of thumb, the value of R1



Note 1: The resistor R1 may be required in order to minimize frequency drift due to changes in the V_{CC}. See text description.

FIGURE 1. Crystal Connection to DP83910A

(see text for component values) should be made equal to five times the motional resistance of the crystal.

The motional resistance of 20 MHz crystals is usually in the range of 10 Ω to 30 Ω . This implies that a reasonable value for R1 should be in the range of 50 Ω -150 Ω .

The decision of whether or not to include R1 should be based upon measured variations of crystal frequency as each of the circuit parameters is varied.

According to the IEEE 802.3 standard, the entire oscillator circuit (crytsal and amplifier) must be accurate to 0.01%. When using a crystal, the X1 pin is not guaranteed to provide a TTL compatible logic output, and should not be used to drive external standard logic. If additional logic needs to be driven, then an external oscillator should be used, as described in the following.

3.2 OSCILLATOR MODULE OPERATION

If the designer wishes to use a crystal clock oscillator, one that provides the following should be employed: 1) TTL or CMOS output with a 0.01% frequency tolerance

2) 40%-60% duty cycle

3) ≥ 2 TTL load output drive (I_OL = 3.2 mA)

3.0 Functional Description (Continued)

The circuit is shown in *Figure 2*. (Additional output drive may be necessary if the oscillator must also drive other components.) When using a clock oscillator it is still recommended that the designer connect the oscillator output to the X1 pin and tie the X2 pin to ground.

3.3 MANCHESTER ENCODER AND DIFFERENTIAL DRIVER

The encoder begins operation when the Transmit Enable input (TXE) goes high and converts clock and NRZ data to Manchester data for the transceiver. For the duration of TXE remaining high, the Transmitted Data (TXD) is encoded for the transmit-driver pair (TX \pm). TXD must be valid on the rising edge of Transmit Clock (TXC). Transmission ends when TXE goes low. The last transition is always positive; it occurs at the center of the bit cell if the last bit is a one, or at the end of the bit cell if the last bit is a zero.

The differential transmit pair from the secondary of the isolation transformer drives up to 50 meters of twisted pair AUI cable. These outputs are source followers which require two 270 Ω pull-down resistors to ground.

The DP83910A allows both half-step and full-step to be compatible with Ethernet I and IEEE 802.3. With the SEL pin low (for Ethernet I), transmit+ is positive with respect to transmit- during idle; with SEL high (for IEEE 802.3), transmit+ and transmit- are equal in the idle state. This provides zero differential voltage to operate with transformer coupled loads.



FIGURE 2. DP83910A Connection for Oscillator Module

4.0 Connection Diagrams



3.4 MANCHESTER DECODER

The decoder consists of a differential receiver and a PLL to separate Manchester encoded data stream into clock signals and NRZ data. The differential input must be externally terminated with two 39 Ω resistors connected in series if the standard 78 Ω transceiver drop cable is used; in Thin-Ethernet applications, these resistors are optional. To prevent noise from falsely triggering the decoder, a squelch circuit at the input rejects signals with levels less than -175 mV. Once the input exceeds the squelch requirements, Carrier Sense (CRS) is asserted. Receive data (RXD) and receive clock (RXC) become valid typically within 6 bit times. The DP83910A may tolerate bit jitter up to 18 ns in the received data.

The decoder detects the end of a frame when no more midbit transitions are detected. Within one and a half bit times after the last bit, carrier sense is de-asserted. Receive clock stays active for five more bit times after CRS goes low to guarantee the receive timings of the DP8390 NIC.

3.5 COLLISION TRANSLATOR

When the Ethernet transceiver (DP8392 CTI) detects a collision, it generates a 10 MHz signal to the differential collision inputs (CD \pm) of the DP83910A. When these inputs are detected active, the DP83910A translates the 10 MHz signal to an active high level for the controller. The controller uses this signal to back off its current transmission and reschedule another one.

The collision differential inputs are terminated the same way as the differential receive inputs. The squelch circuitry is also similar, rejecting pulses with levels less than -175 mV.

3.6 LOOPBACK FUNCTIONS

When the Loopback input (LBK) is asserted high, the DP83910A redirects its transmitted data back into its receive path. This feature provides a convenient method for testing both chip and system level integrity. The transmit driver and receive input circuitry are disabled in loopback mode.





4-Pin DIP	28-Pin PCC	Name	1/0	Description
1	1	COL	0	COLLISION DETECT OUTPUT: Generates an active high signal when 10 MHz collision signal is detected.
2	2	RXD	0	RECEIVE DATA OUTPUT: NRZ data output from the PLL. This signal must be sampled on the rising edge of receive clock.
3	3	CRS	0	CARRIER SENSE: Asserted on the first valid high-to-low transition on the RX \pm pair. Remains active until 1.5 bit times after the last bit in data.
4	4	RXC	0	RECEIVE CLOCK: The receive clock from the Manchester data after the PLL has locked. Remains active 5 bit times after deasserting CRS.
5	5	SEL	I	MODE SELECT: When high, transmit + and transmit - are the same voltage in the idle state. When low, transmit + is positive with respect to transmit - in the idle state, at the transformer's primary.
6	7	V _{SS}		GROUND PIN
	8	V _{SS}		
	9	V _{SS}		
7	10	LBK	I	LOOPBACK: When high, the loopback mode is enabled.
8	11	X1	I	CRYSTAL OR EXTERNAL OSCILLATOR INPUT
9	12	X2	0	CRYSTAL FEEDBACK OUTPUT: Used in crystal connections only. Connected to ground when using an external oscillator.
10	13	TXD	I	TRANSMIT DATA INPUT: NRZ data input from the controller. The data is combined with the transmit clock to produce Manchester data. TXD is sampled on the rising edge of transmit clock.
11	14	TXC	0	TRANSMIT CLOCK: The 10 MHz clock derived from the 20 MHz oscillator.
12	15	TXE	I	TRANSMIT ENABLE: The encoder begins operation when this input i asserted high.
13	16	TX-	0	TRANSMIT OUTPUT: Differential line driver which sends the encoded
14	17	TX+		data to the transceiver. The outputs are source followers which require 270 Ω pull-down resistors.
15	6	NC		NO CONNECTION: This may be tied to V _{SS} for the PLCC version to b compatible with the DP8391.
16	18	NC		NO CONNECTION
17	19	TEST	I	FACTORY TEST INPUT: Used to check the chip's internal functions. May be tied low or have a 0.01 μf bypass capacitor to ground (for compatibility with the bipolar DP8391) during normal operation.
18	20	V _{DD}		POWER CONNECTION
19	21	V _{DD}		
	22	V _{DD}		
	23	VDD		
20	24	NC		
21	25	RX-		RECEIVE INPUT: Differential receive input pair from the transceiver.
22	20	HX+		
23 24	27			COLLISION INPUT: Differential collision pair input from the transceiver.
£7	20		I	

7.0 Absolute Maximum Ratings

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V _{CC})	-0.5V to +7V
DC Input Voltage (V _{IN})	-0.5V to V _{CC} $+0.5V$
DC Output Voltage (V _{OUT})	$-0.5 V$ to $V_{\mbox{CC}}$ $+0.5 V$
Differential Input Voltage	-5.5 to +16V
Differential Output Voltage	0 to 16V
Power Dissipation	500 mW
Storage Temperature	-65°C to +150°C

Note: Absolute maximum ratings are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits.

*Note: An asterisk following a parameter's symbol indicates that the parameter has been characterized but not tested.

Note: All specifications in this datasheet are valid only if the mandatory isolation is employed and all differential signals are taken to exist at the AUI side of the pulse transformer.

8.0 DC Specifications $T_A = 0^\circ C$ to 70°C, $V_{CC} = 5V \pm 5\%$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Controlle	r Interface Pins (COL, RXD, CR	S, RXC, SEL, LBK, TXD, TXC and TXE	E)			
V _{IH}	Input High Voltage		2.0			V
V _{IL}	Input Low Voltage				0.8	V
I _{IN}	Input Leakage	$V_{IN} = V_{CC} \text{ or } GND$	-1.0		1.0	μΑ
V _{OH}	Output High Voltage	(TTL) I _{OH} = 2.0 mA (CMOS) I _{OH} = 20 μA	3.5 V _{CC} - 0.1			V V
V _{OL}	Output Low Voltage	(TTL) I _{OL} = 2.0 mA (CMOS) I _{OL} = 20 μA			0.4 0.1	V V
Icco	Operating V _{CC} Supply Current (Note 1)	10 Mbit/sec			70	mA
I _{CCS}	Stand By V _{CC} Supply Current (Note 2)	10 Mbit/sec			65	mA
Differenti	al Pins (TX \pm , RX \pm , and CD \pm)					
V _{OD}	Diff. Output Voltage (TX \pm)	78Ω Termination, and 270Ω from each to GND (<i>Figure 4</i>)	±550		±1200	mV
V _{OB} *	Diff. Output Voltage Imbalance (TX±)	78Ω Termination, and 270Ω from each to GND (<i>Figure 4</i>)		40		mV
V _U *	Undershoot Voltage (TX \pm)	78Ω Termination, and 270Ω from each to GND (<i>Figure 4</i>)		100		mV
V _{DS}	Diff. Squelch Threshold (RX \pm and CD \pm)		- 175		-300	mV
V _{CM}	Diff. Input Common Mode Voltage (RX \pm and CD \pm) (Note 3)		0		5.5	v
Oscillator	[•] Pins (X1 and X2)					
V _{IH}	X1 Input High Voltage	X1 is connected to an oscillator, and X2 is grounded	2.0			v
VIL	X1 Input Low Voltage	X1 is connected to an oscillator, and X2 is grounded			0.8	V
losc	X1 Input Current	$X1 = V_{CC} \text{ or } GND$ $X2 = GND$	-2		+2	mA

Note 1: This measurement was made while the DP83910A was undergoing transmission, reception, and collision detection. Also, this value was not measured instantaneously, but averaged over a span of several milliseconds. ($V_{IN} = 2.4V$ or 0.4V and $I_0 = 0$ mA).

Note 2: This measurement was made while the DP83910A was sitting idle with TXE low. Also, this value was not measured instantaneously, but averaged over a span of several milliseconds. ($V_{IN} = 2.4V$ or 0.4V and $I_0 = 0$ mA).

Note 3: This parameter is guaranteed by design and is not tested.

t _{XTH} t _{XTL}	V1 to Transmit Cleak Llink	Min	Max		Units	
t _{XTL}	AT to Transmit Clock High	5	30		ns	
	t _{XTL} X1 to Transmit Clock Low		30		ns	
	TXC t TCl t	hg (Start of Packet) t TCh t TEs t TEs t TDh t TDh t TOh t TOh t TOh t TOh t TOh				
	TX +/-			TL/F/9365-4		
ransmit	Specifications (Start of Pac	Kel)			1	
Fransmit Symbol	Specifications (Start of Pac Parameter	Kel)	Min	Max	Uni	
Transmit Symbol t _{TCh}	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1)		Min 40	Max 60	Unit	
Transmit Symbol t _{TCh} t _{TCl}	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1) Transmit Clock Low Time (Note 1)		Min 40 40	Max 60 60	Unit ns ns	
Symbol t _{TCh} t _{TCl} t _{TCc} *	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1) Transmit Clock Low Time (Note 1) Transmit Clock Cycle Time (Note 1)		Min 40 40 99.99	Max 60 60 100.01	Unit ns ns ns	
Symbol t _{TCh} t _{TCl} t _{TCc} *	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1) Transmit Clock Low Time (Note 1) Transmit Clock Cycle Time (Note 1) Transmit Clock Rise Time (20% to 80%) (C	C _L = 30 pF)	Min 40 40 99.99	Max 60 60 100.01 8	Unit ns ns ns ns	
Symbol tTCh tTCI tTCc* tTCr* tTCr*	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1) Transmit Clock Low Time (Note 1) Transmit Clock Cycle Time (Note 1) Transmit Clock Rise Time (20% to 80%) (C Transmit Clock Fall Time (80% to 20%) (C	C _L = 30 pF) L = 30 pF)	Min 40 40 99.99	Max 60 60 100.01 8 8	Unit ns ns ns ns	
Symbol tTCh tTCI tTCe* tTCr* tTCr* tTCs* tTCs*	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1) Transmit Clock Low Time (Note 1) Transmit Clock Cycle Time (Note 1) Transmit Clock Rise Time (20% to 80%) (C Transmit Clock Fall Time (80% to 20%) (C Transmit Enable Setup Time to Rising Edge	C _L = 30 pF) <u>L</u> = 30 pF) e of TXC (Note 1)	Min 40 99.99	Max 60 60 100.01 8 8	Unit ns ns ns ns ns ns	
Symbol tTCh tTCI tTCc* tTCr* tTCf* tTCf* tTCs tTCs	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1) Transmit Clock Low Time (Note 1) Transmit Clock Cycle Time (Note 1) Transmit Clock Rise Time (20% to 80%) (C Transmit Clock Fall Time (80% to 20%) (C Transmit Enable Setup Time to Rising Edge Transmit Data Setup Time from Rising Edge	$C_{L} = 30 \text{ pF}$ L = 30 pF e of TXC (Note 1) e of TXC (Note 1)	Min 40 99.99	Max 60 60 100.01 8 8	Unit ns ns ns ns ns ns	
Symbol trCh tTCI tTCC* tTCr* tTCf* tTCf* tTDs tTDh	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1) Transmit Clock Low Time (Note 1) Transmit Clock Cycle Time (Note 1) Transmit Clock Rise Time (20% to 80%) (C Transmit Clock Fall Time (80% to 20%) (C Transmit Enable Setup Time to Rising Edge Transmit Data Setup Time from Rising Edge Transmit Data Hold Time from Rising Edge of TXC	$C_{L} = 30 \text{ pF})$ $L = 30 \text{ pF})$ e of TXC (Note 1) e of TXC (Note 1)	Min 40 99.99 20 20 0	Max 60 60 100.01 8 8	Unit ns ns ns ns ns ns ns	
Symbol tTCh tTCl tTCc* tTCr* tTCf* tTCf* tTDh tTOd	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1) Transmit Clock Low Time (Note 1) Transmit Clock Cycle Time (Note 1) Transmit Clock Rise Time (20% to 80%) (C Transmit Clock Fall Time (80% to 20%) (C Transmit Enable Setup Time to Rising Edge Transmit Data Setup Time from Rising Edge Transmit Data Hold Time from Rising Edge of TXC Transmit Output Delay from Rising Edge of	$C_{L} = 30 \text{ pF})$ $L = 30 \text{ pF})$ $e \text{ of TXC (Note 1)}$ $f \text{ TXC (Note 1)}$	Min 40 99.99 20 20 0	Max 60 60 100.01 8 8 8 8	Unit ns ns ns ns ns ns ns ns	
Symbol tTCh tTCI tTCC* tTCf* tTCf* tTCf* tTDs tTDh tTOd tTOf*	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1) Transmit Clock Low Time (Note 1) Transmit Clock Cycle Time (Note 1) Transmit Clock Rise Time (20% to 80%) (C Transmit Clock Fall Time (80% to 20%) (C Transmit Enable Setup Time to Rising Edge Transmit Data Setup Time from Rising Edge Transmit Data Hold Time from Rising Edge of TXC Transmit Output Delay from Rising Edge of Transmit Output Fall Time (80% to 20%)	$C_{L} = 30 \text{ pF})$ $L = 30 \text{ pF})$ e of TXC (Note 1) f TXC (Note 1)	Min 40 40 99.99 20 20 0	Max 60 60 100.01 8 8 8 8 	Unit ns ns ns ns ns ns ns ns	
Symbol tTCh tTCI tTCC* tTCf* tTCf* tTCs tTDs tTDh tTOd tTOf* tTOf* tTOf* tTOf* tTOf* tTOf*	Specifications (Start of Pac Parameter Transmit Clock High Time (Note 1) Transmit Clock Low Time (Note 1) Transmit Clock Cycle Time (Note 1) Transmit Clock Rise Time (20% to 80%) (C Transmit Clock Fall Time (80% to 20%) (C Transmit Enable Setup Time to Rising Edge Transmit Data Setup Time from Rising Edge Transmit Data Setup Time from Rising Edge Transmit Data Hold Time from Rising Edge of TXC Transmit Output Delay from Rising Edge of Transmit Output Fall Time (80% to 20%) Transmit Output Rise Time (20% to 80%)	$C_{L} = 30 \text{ pF})$ $L = 30 \text{ pF})$ e of TXC (Note 1) f TXC (Note 1)	Min 40 99.99 20 20 0	Max 60 60 100.01 8 8 8 8 65 7 7 7	Unit ns ns ns ns ns ns ns ns ns	







Loopback Specifications

Symbol	Parameter	Min	Мах	Units
t _{LBs}	Loopback Setup Time (Note 1)	50		ns
t _{LBh}	Loopback Hold Time (Note 1)	1000		ns

Note 1: This parameter is guaranteed by design and is not tested.

AC Timing Test Conditions



 $\label{eq:capacitance} \textbf{Capacitance} \ \textbf{T}_{A} = 25^{\circ} \textbf{C}, \ \textbf{f} = 1 \ \textbf{MHz}$

Symbol	Parameter	Тур	Units
C _{IN}	Input Capacitance	7	pF
COUT	Output Capacitance	7	pF



FIGURE 4

Note: In the above diagram, the TX+ and TX- signals are taken from the AUI side of the isolation (pulse transformer). The pulse transformer used for all testing is the Pulse Engineering PE64103.





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